MAZZxxxH Series

Silicon planar type

For surge absorption circuit

Features

- Four elements anode-common type
- Power dissipation P_D : 200 mW

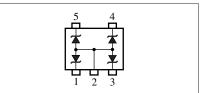
	Unit: mm
	0.7±0.1
5'	
1: Cathode 2: Anode 3: Cathode	5: Cathode 4
5. Culloud	SMini5-F1 Package

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation*	P _D	200	mW	
Junction temperature	Tj	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	

Note) *: $P_D = 200 \text{ mW}$ achieved with a printed circuit board.

Internal Connection



Common Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions			Min	Тур	Max	Unit
Zener voltage *	oltage * V _Z I _Z Spe		Specified value				V	
Zener rise operating resistance	R _{ZK}	IZ	I_ Specified value		efer to the list of the ectrical characteristics			Ω
Zener operating resistance	R _Z	IZ	Specified value	withi	within part numbers			Ω
Reverse current	I _R	V _R	Specified value					μΑ

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Electrostatic breakdown voltage: $\pm 10 \text{ kV}$

Test method: IEC1000-4-2 (C = 150 pF, R = 330 Ω , Contact discharge: 10 times)

3. *: The temperature must be controlled 25°C for V_{Z} mesurement.

 V_Z value measured at other temperature must be adjusted to $V_Z \left(25^\circ C\right)$

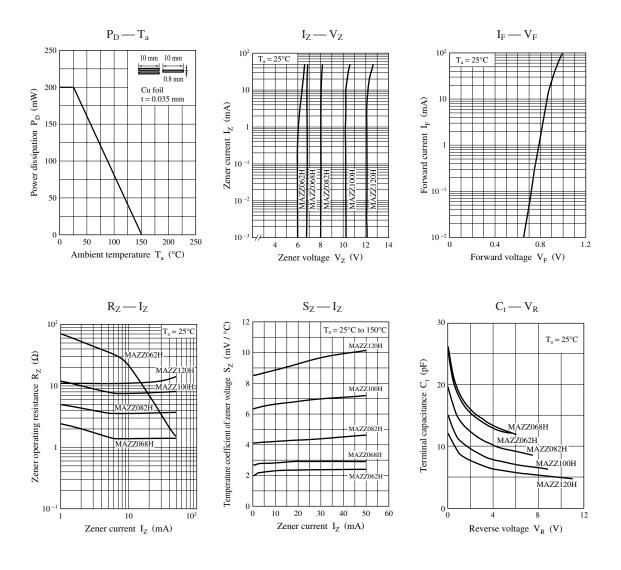
 V_Z guaranted 20 ms after current flow.

MAZZxxxH Series

Panasonic

Part number	Zener voltage V _Z (V)			Reverse current I _R (mA)		$ \begin{array}{c c} \text{Zener} & \text{Zener rise} \\ \text{operating} \\ \text{resistance} \\ \text{R}_{Z}\left(\Omega\right) & \text{R}_{ZK}\left(\Omega\right) \end{array} $		Marking symbol	
	Min	Nom	Мах	I _Z (mA)	Max	V _R (V)	l _z = 5 mA Max	l _z =0.5 mA Max	
MAZZ062H	5.8	6.2	6.6	5	0.2	4	50	100	6.2Z
MAZZ068H	6.4	6.8	7.2	5	0.1	4	30	60	6.8Z
MAZZ082H	7.7	8.2	8.7	5	0.1	5	30	60	8.2Z
MAZZ100H	9.4	10.0	10.6	5	0.05	7	30	60	10Z
MAZZ120H	11.4	12.0	12.7	5	0.05	9	30	80	12Z

Electrical characteristics within part numbers $T_a = 25^{\circ}C \pm 3^{\circ}C$



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